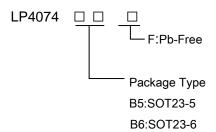


### 600mA Standalone Linear Li-Ion Battery Charger

### **General Description**

The LP4074 is a complete constant-current/constant-voltage linear charger for single cell lithium-ion batteries. Its SOT23-5 package and low external component count make the LP4074 ideally suited for portable applications. Furthermore, the LP4074 is specifically designed to work within USB power specifications. No external sense resistor is needed, and no blocking diode is required due to the internal MOSFET architecture. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge voltage is fixed at 4.2V, and the charge current can be programmed externally with a single resistor. The LP4074 automatically terminates the charge cycle when the charge current drops to 1.5/10th the programmed value after the final float voltage is reached. When the input supply (wall adapter or USB supply) is removed, the LP4074 automatically enters a low current state, dropping the battery drain current to less than 1µA. Other features include charge current monitor, automatic recharge and a status pin to indicate charge termination and the presence of an input voltage

### **Order Information**



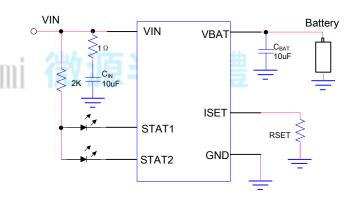
## **Applications**

- ♦ Portable Media Players/MP3 players
- ♦ Cellular and Smart mobile phone
- ♦ PDA/DSC
- ♦ Bluetooth Applications

### **Features**

- Programmable Charge Current Up to 600mA
- No MOSFET, Sense Resistor or Blocking Diode Required
- Constant-Current/Constant-Voltage Operation with Thermal Regulation to Maximize
- Charge Rate Without Risk of Overheating
- ♦ 4.2V Charge Voltage with ± 1% Accuracy
- Charge Current Monitor Output for Gas Gauging
- Automatic Recharge
- 3V Trickle Charge Threshold
- Charging OTP
- Package in SOT23-5/SOT23-6

## **Typical Application Circuit**



## **Marking Information**

Part	Marking	Package	Shipping	
LP4074B5F	LP4074	SOT23-5	3K/REEL	
	YWX			
LP4074B6F	LP4074	SOT23-6	3K/REEL	
	YWX			

Marking indication:

Y:Production year W:Production week X:Production batch.

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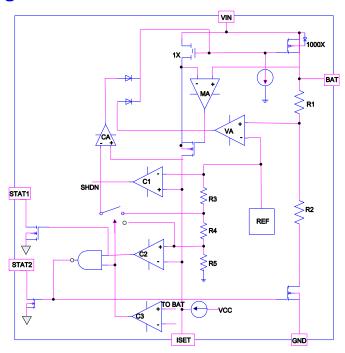
# **Functional Pin Description**

Package Type	SOT23-5	SOT23-6
	Top View	Top View
Pin	STAT1 1 5 ISET	STAT1 1 6 ISET
Configurations	GND 2	GND 2 5 STAT2
	BAT 3 4 VIN	BAT 3 4 VIN

Р	in	Nama	Description	
SOT23-5	SOT23-6	Name	Description	
			Open-Drain Charge Status Output. When the battery is charging, the STAT pin	
1	1	STAT1	is pulled low by an internal N-channel MOSFET. When the charge cycle is	
		P Semi	completed, the pin is pulled High.	
2	2	GND	Ground.	
2	2	BAT	Charge Current Output. Provides charge current to the battery and regulates	
3 3		DAI	the final float voltage to 4.2V.	
4	4	VIN	Positive Input Supply Voltage.	
			Open-Drain Charge Status Output. When the battery is charging, the STAT pin	
	5 is pulle		is pulled High by an internal N-channel MOSFET. When the charge cycle is	
compl			completed, the pin is pulled Low.	
			Charge Current Program and Charge Current Monitor Pin. The charge current	
			is programmed by connecting a 1% resistor, R <sub>ISET</sub> , to ground. When charging in	
5 6 ISET		ISET	constant-current mode, this pin servos to 1V. In all modes, the voltage on this	
pin can be used to measure the cha			pin can be used to measure the charge current using the following formula:	
IBAT=1000/R <sub>ISET</sub>		IBAT=1000/R <sub>ISET</sub>		

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# **Function Block Diagram**



# **Absolute Maximum Ratings Note1**

<b></b>	Input to GND(VIN)	0.3V to 10V
<b></b>	Other Pin to GND	
<b></b>	BAT Short-circuit Duration	Continuous
<b></b>	Maximum Junction Temperature	125°C
<b></b>	Operating Junction Temperature Range (TJ)	20°C to 85°C
<b></b>	Maximum Soldering Temperature (at leads, 10 sec)	260°C

**Note1.** Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Thermal Information**

$\Leftrightarrow$	Maximum Power Dissipation (SO123-5, PD, 1 <sub>A</sub> =25°C	;) (U	J.45VV

♦ Thermal Resistance (SJA) ------ 250°C/M

# **ESD Susceptibility**

$\diamond$	HBM(Human Body Mode)		2KV
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♦ MM(Machine Mode) ------ 200V

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### **Electrical Characteristics**

 $(T_A = 25$ °C.  $V_{IN} = 5V$ , unless otherwise noted.)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNITS
VIN	Adapter/USB Voltage Range		4.5	5	6.5	V
I <sub>IN</sub>	Input Supply Current	Standby Mode (Charge Terminated)		50		uA
$V_{FLOAT}$	Regulated Output (Float) Voltage	$I_{BAT} = 40mA$	4.158	4.2	4.242	V
		R <sub>ISET</sub> = 10K , Current Mode		100		
I <sub>BAT</sub>	BAT Pin Current	R <sub>ISET</sub> = 2K , Current Mode		500		mA
IDAI	Division Gallon	Standby Mode, $V_{BAT} = 4.2V$ Sleep Mode, $V_{IN} = 0V$		±1		uA
$V_{TRIKL}$	Trickle Charge Threshold Voltage	R <sub>ISET</sub> = 10k, V <sub>BAT</sub> Rising		3		V
V <sub>TRHYS</sub>	Trickle Charge Hysteresis Voltage	R <sub>ISET</sub> = 10K		150		mV
	Trially about a sure of	V <sub>BAT</sub> < V <sub>TRIKL</sub> , R <sub>ISET</sub> =10K		40		
I <sub>TRIKL</sub>	Trickle charge current	V <sub>BAT</sub> < V <sub>TRIKL</sub> , R <sub>ISET</sub> =2K		200		- mA
Vuv	V <sub>IN</sub> Undervoltage Lockout Threshold	From V <sub>IN</sub> Low to High		3.8		V
V <sub>UVHYS</sub>	V <sub>IN</sub> Undervoltage Lockout Hysteresis			200		mV
V <sub>ASD</sub>	V <sub>IN</sub> –V <sub>BAT</sub> Lockout Threshold Voltage	onComi 245百斗	省首	150		mV
I <sub>TERM</sub>	C/10 Termination Current Threshold	IELOGIII 10X 1128 1	- 43	15		% I <sub>BAT</sub>
$V_{ISET}$	ISET Pin Voltage	R <sub>ISET</sub> = 10K,Charge Mode		1		V
V <sub>STAT</sub>	STAT1/STAT2 Pin Output Low Voltage	I <sub>STAT</sub> = 5mA			0.5	V
ISTAT	STAT1/2 Pin Weak Pull-Down Current	I <sub>CHRG</sub> = 5V			5	uA
$\Delta V_{RECHRG}$	Recharge Battery Threshold Voltage	V <sub>FLOAT</sub> - V <sub>RECHRG</sub>		200		mV

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### **Preliminary Datasheet**

LP4074

## **Applications Information**

The LP4074 is a single cell lithium-ion battery charger using a constant-current/constant-voltage algorithm. It can deliver up to 600mA of charge current (using a good thermal PCB layout) with a final float voltage accuracy of ± 1%. The LP4074 includes an internal P-channel power MOSFET and thermal regulation circuitry. No blocking diode or external current sense resistor is required; thus, the basic charger circuit requires only three external components. Furthermore, the LP4074 is capable of operating from a USB power source.

#### **Normal Charge Cycle**

A charge cycle begins when the voltage at the VIN pin rises above the UVLO threshold level and a 1% program resistor is connected from the ISET pin to ground or when a battery is connected to the charger output. If the BAT pin is less than 2.9V, the charger enters trickle charge mode.

When the BAT pin voltage rises above 2.9V, the charger enters constant-current mode, where the programmed charge current is supplied to the battery. When the BAT pin approaches the final float voltage (4.2V), the LP4074 enters constant-voltage mode and the charge current begins to decrease. When the charge current drops to 1.5/10 of the programmed value the charge cycle ends.

#### **Programming Charge Current**

The charge current is programmed using a single resistor from the ISET pin to ground. The battery charge current is 1000 times the current out of the ISET pin. The program resistor and the charge current are calculated using the following equations:

RISET=1000÷IBAT.

I<sub>BAT</sub>=1000÷R<sub>ISET</sub>

The charge current out of the BAT pin can be determined at any time by monitoring the ISET pin voltage using the following equation:

IBAT=VISET÷RISET×1000

#### Charge Status Indicator (CHRG)

The charge status output has two different states: strong pull-down (~5mA) and high impedance. The strong pull-down state indicates that the LP4074 is in a charge cycle. High impedance indicates that the charge cycle complete or the LP4074 is in under voltage lockout mode: either V<sub>IN</sub> is less than 150mV above the BAT pin voltage or insufficient voltage is applied to the VIN pin. A microprocessor can be used to distinguish between these two states.

Charge Stage	STAT1 Status	STAT2 Status	
Charging	Low	High	
Charge Complete	High	Low	

#### **Charge Termination**

A charge cycle is terminated when the charge current falls to 1.5/10th the programmed value after the final float voltage is reached. This condition is detected by using an internal, filtered comparator to monitor the ISET pin. When the ISET pin voltage falls below 100mV for longer than T<sub>TERM</sub> (typically 1ms), charging is terminated. The charge current is latched off and the LP4074 enters standby mode, where the input supply current drops to 50µA. When charging, transient loads on the BAT pin can cause the ISET pin to fall below 150mV for short periods of time before the DC charge current has dropped to 1.5/10th the programmed value. The 1ms filter time (T<sub>TERM</sub>) on the termination comparator ensures that transient loads of this nature do not result in premature charge cycle termination. Once the average charge current drops below 1.5/10th the programmed value, the LP4074 terminates the charge cycle and ceases to provide any current through the BAT pin. In this state, all loads on the BAT pin must be supplied by the battery. The LP4074 constantly monitors the BAT pin voltage in standby mode. If this voltage drops below the 4.0V recharge threshold (VRECHRG), another charge cycle begins and current is once again supplied to the battery. To manually restart a charge cycle when in standby mode, the input voltage must be removed and reapplied.

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## **Preliminary Datasheet**

**LP4074** 

#### **Thermal Limit**

An internal thermal feedback loop reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 125°C. This feature protects the LP4074 from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the LP4074. The charge current can be set according to typical (not worst-case) ambient temperature with the assurance that the charger will automatically reduce the current in worst-case conditions.

#### **Automatic Recharge**

Once the charge cycle is terminated, the LP4074 continuously monitors the voltage on the BAT pin using a comparator with a 2ms filter time (T<sub>RECHARGE</sub>). A charge cycle restarts when the battery voltage falls below 4.0V (which corresponds to approximately 80% to 90% battery capacity). This ensures that the battery is kept at or near a fully charged condition and eliminates the need for periodic charge cycle initiations. CHRG output enters a strong pull-down state during recharge cycles.

#### **Power Dissipation**

The conditions that cause the LP4074 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET—this is calculated to be approximately:

PD=(V<sub>IN</sub> - V<sub>BAT</sub>) × I<sub>BAT</sub>

#### **VIN Bypass Capacitor**

Many types of capacitors can be used for input bypassing; however, caution must be exercised when using multilayer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charger input to a live power source. Adding a  $1.5\Omega$  resistor in series with an X5R ceramic capacitor will minimize start-up voltage transients.

#### **Layout Considerations**

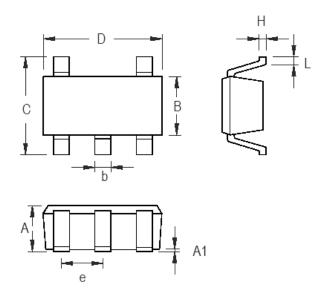
- For the main current paths as indicated in bold lines, keep their traces short and wide.
- Put the input capacitor as close as possible to the device pins (VIN and GND).
- Connect all analog grounds to a command node and then connect the command node to the power ground behind the output capacitors.



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# **Packaging Information**

### SOT23-5



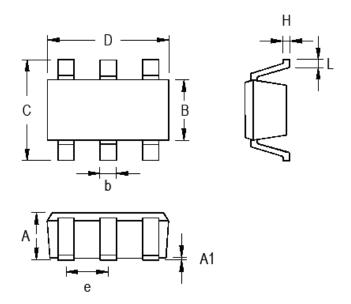
Cumbal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
А	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
В	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
С	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
е	0.838	1.041	0.033	0.041
Н	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-5 Surface Mount Package

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### SOT23-6



### . P Semi

Cumbal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max 1	Min	Max
Α	0.889	1.295	0.031	0.051
A1	0.000	0.152	0.000	0.006
В	1.397	1.803	0.055	0.071
b	0.250	0.560	0.010	0.022
С	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
е	0.838	1.041	0.033	0.041
Н	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

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